

6N138-L, 6N139-L

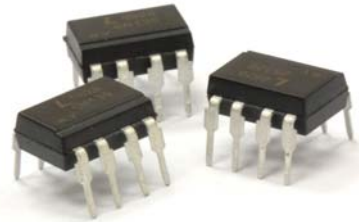
Single Channel, High Speed Optocouplers



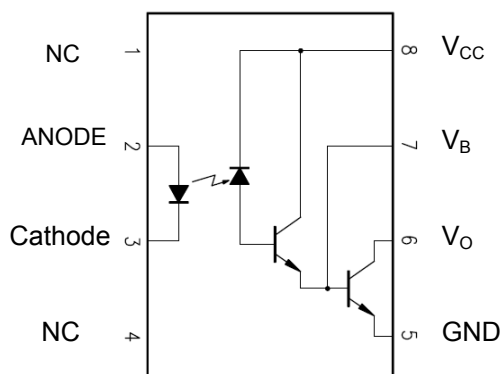
Dec.2008

Description

These high gain series couplers use a light emitter diode and an integrated high gain photo detector to provide extremely high current transfer ratio between input and output. Separate pins for the photodiode and output stage result in TTL compatible saturation voltage and high speed operation. Where desired the V_{CC} and V_O terminals may be tied together to achieve conventional photo darlington operation. A base access terminal allows a gain bandwidth adjustment to be made.



Functional Diagram



6N138-L / 6N139-L

Truth Table (Positive Logic)

LED	OUT
ON	L
OFF	H

A 0.1 μ F bypass Capacitor must be connected between Pin8 and Pin5

Features

- High current transfer ratio – 2000% typical.
- Low input current requirements – 0.5mA
- High output current – 60mA
- CTR guarantee – 0~70°C.
- Instantaneous common mode rejection 10KV/ μ sec
- TTL compatible output – 0.1V V_{OL} typical
- UL, CSA approved.

APPLICATIONS

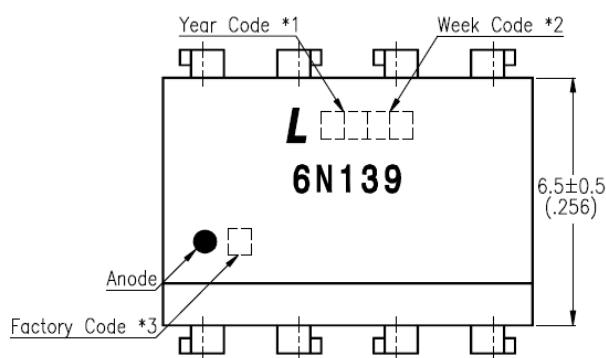
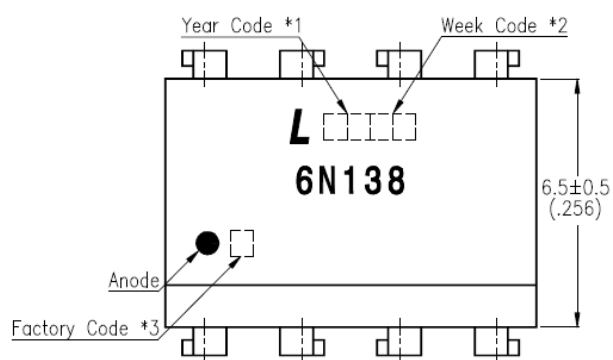
- Digital logic ground isolation
- Low input current line receiver
- Telephone ring detector
- EIA-RS-232C line receiver
- Current loop receiver
- High common mode noise line receiver

Ordering Information

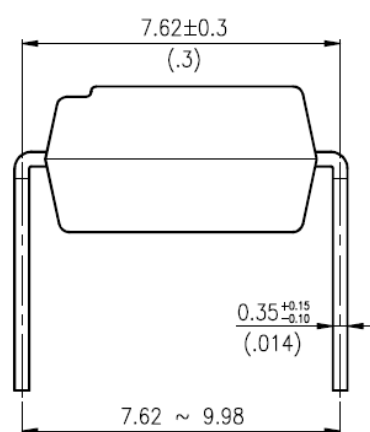
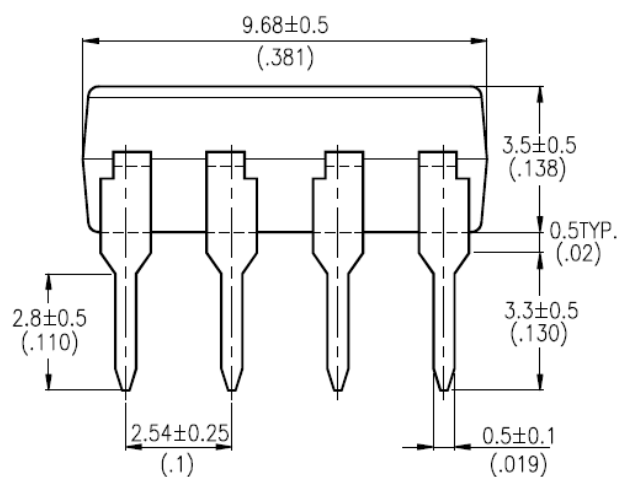
Part	Option	Minimum CMR		CTR	Remarks
		dV/dt (V/μs)	V _{CM} (V)		
6N138	-L				Single Channel, DIP-8
	M-L			400	Single Channel, Wide Lead Spacing
	S-L	1,000	10		Single Channel, SMD-8
6N139	-L				Single Channel, DIP-8
	M-L			300	Single Channel, Wide Lead Spacing
	S-L				Single Channel, SMD-8

OUTLINE DIMENSIONS

8-pin DIP Package (6N138-L / 6N139-L)

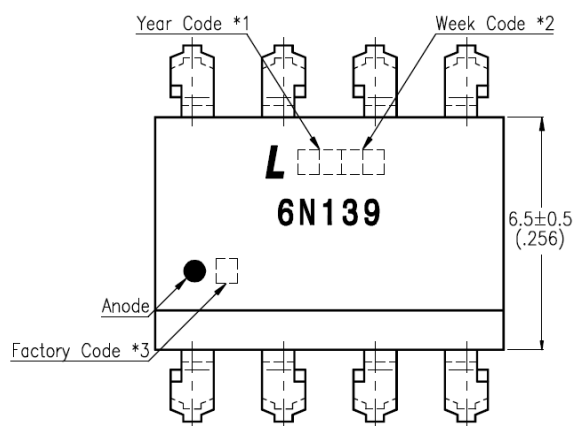
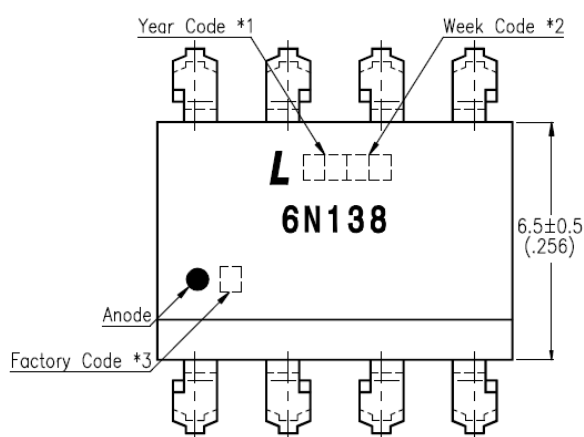


- *1. Year date code.
 - *2. 2-digit work week.
 - *3. Factory identification mark
(Z : Taiwan, Y : Thailand).
- Dimensions are in Millimeters and (Inches).



OUTLINE DIMENSIONS

8-pin DIP Wide Lead Spacing Package (6N138M-L / 6N139M-L)

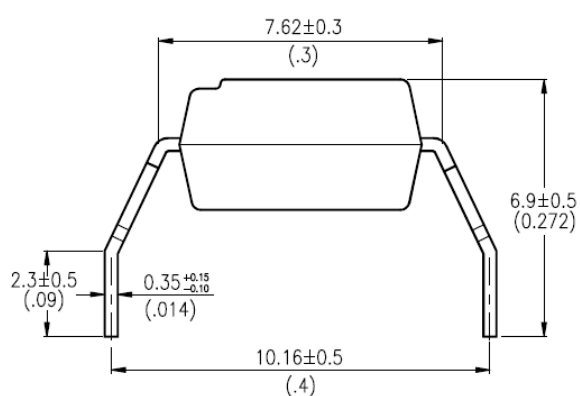
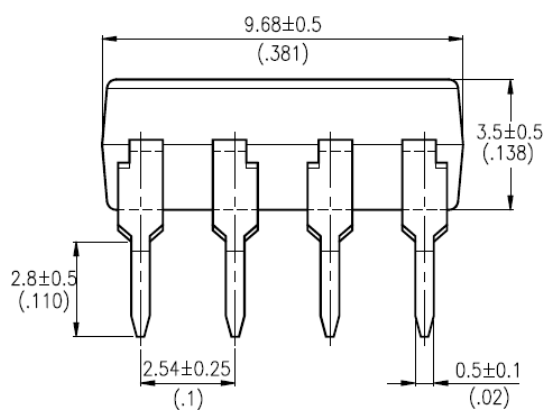


*1. Year date code.

*2. 2-digit work week.

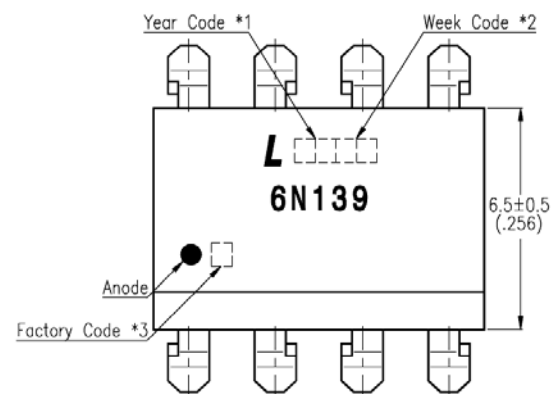
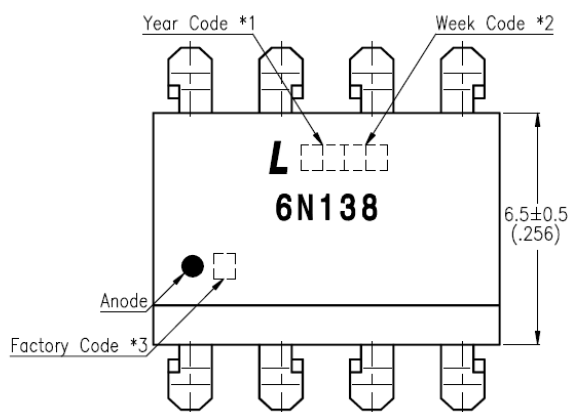
*3. Factory identification mark
(Z : Taiwan, Y : Thailand).

Dimensions are in Millimeters and (Inches).



OUTLINE DIMENSIONS

8-pin DIP Surface Mount Package (6N135S-L / 6N136S-L)

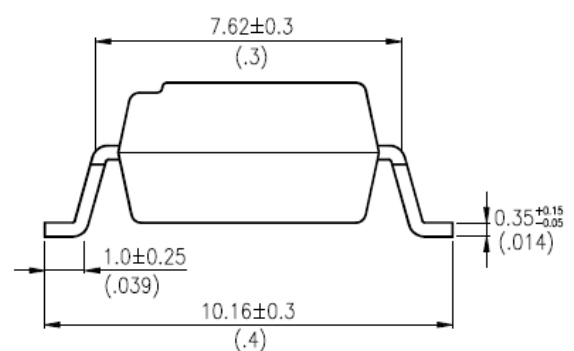
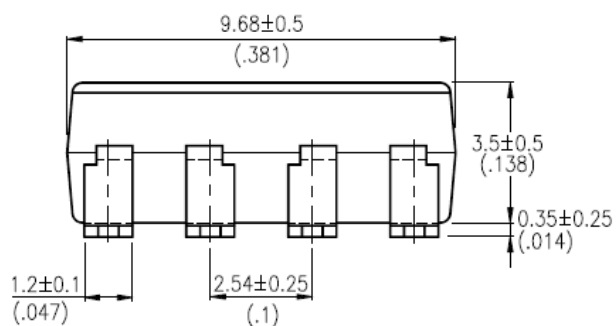


*1. Year date code.

*2. 2-digit work week.

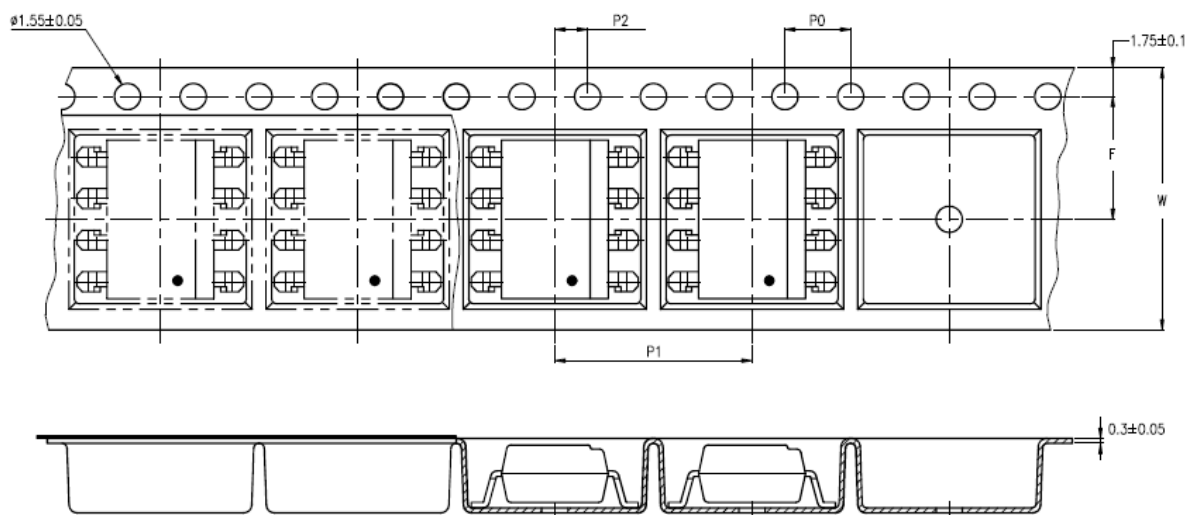
*3. Factory identification mark
(Z : Taiwan, Y : Thailand).

Dimensions are in Millimeters and (Inches).

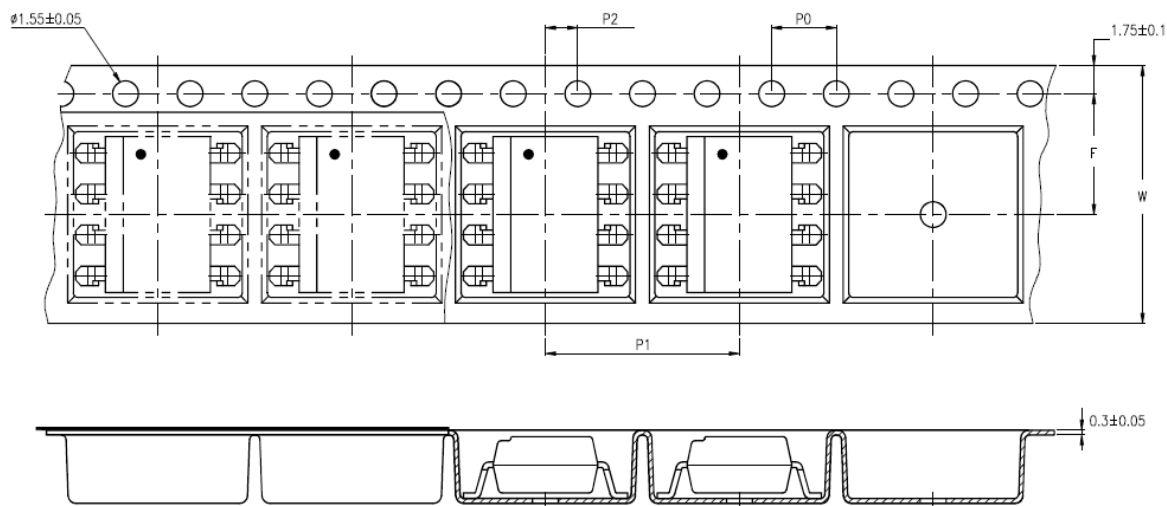


TAPING DIMENSIONS

6N138S/6N139S-TA-L

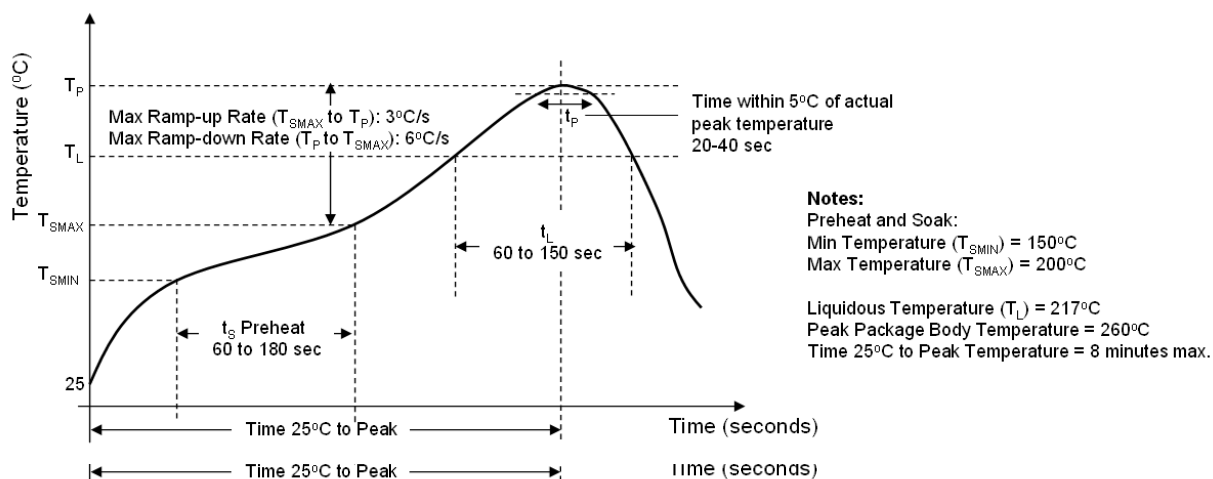


6N138S/6N139S-TA1-L



Description	Symbol	Dimensions in millimeters (inches)
Tape wide	W	16 ± 0.3 (.63)
Pitch of sprocket holes	P0	4 ± 0.1 (.15)
Distance of compartment	F	7.5 ± 0.1 (.295)
	P2	2 ± 0.1 (.079)
Distance of compartment to compartment	P1	12 ± 0.1 (.472)

Recommended Lead Free Reflow Profile



Absolute Maximum Ratings*1

Parameter	Symbol	Device	Min	TYP	Max	Units
Storage Temperature	T _{ST}	6N138-L 6N139-L	-55		125	°C
Operating Temperature	T _A		-40		85	°C
Isolation Voltage	V _{ISO}				5000	V _{RMS}
Supply Voltage	V _{CC}				15	V
Lead Solder Temperature * 2	T _{SOL}				260	°C
Input						
Average Forward Input Current	I _F	6N138-L 6N139-L			20	mA
Reverse Input Voltage	V _R				5	V
Input Power Dissipation	P _I				35	mW
Output						
Average Output Current	I _O	6N138-L 6N139-L			50	mA
Supply Voltage, Output Voltage	V _{CC} , V _O	6N138-L	-0.5		7	V
		6N139-L	-0.5		18	
Output Collector Power Dissipation	P _O	6N138-L 6N139-L			100	mW

1. Ambient temperature = 25°C, unless otherwise specified. Stresses exceeding the absolute maximum ratings can cause permanent damage to the device. Exposure to absolute maximum ratings for long periods of time can adversely affect reliability.

2. 260°C for 10 seconds. Refer to Lead Free Reflow Profile.

Electrical Specifications

Parameters	Test Condition	Symbol	Device	Min	Typ	Max	Units
Input							
Input Forward Voltage	I _F =1.6mA, T _A =25°C	V _F	6N138-L 6N139-L		1.1	1.7	V
Input Forward Voltage Temperature Coefficient	IF=1.6mA	ΔV _F /ΔTa			-1.9		mV/°C
Input Reverse Voltage	I _R = 10μA T _A =25°C	BV _R		5	-	-	V
Input Capacitance	V _F =0; f=1MH _Z	C _{IN}		-	60	-	pF
Detector							
Current transfer ratio	I _F =1.6mA;Vo=0.4V; Vcc=4.5V	CTR	6N138-L	400	2000	-	%
	I _F =0.5mA;Vo=0.4V; Vcc=4.5V		6N139-L	500	1600	-	
	I _F =1.6mA;Vcc=0.4V; Vcc=4.5V			300	1600	-	
Logic low output voltage	I _F =1.6mA;Vcc=4.5V; I _o =4.8mA	V _{OL}	6N138-L	-	0.1	0.4	V
	I _F =0.5mA;Vcc=4.5V; I _o =2mA		6N139-L	-	0.1	0.4	
	I _F =1.6mA;Vcc=4.5V; I _o =8mA						
	I _F =5mA;Vcc=4.5V; I _o =15mA						
	I _F =12mA;Vcc=4.5V; I _o =24mA						
Logic high output current	I _F =0mA, Vo=Vcc=7V T _A =25°C	I _{OH}	6N138-L	-	0.05	250	μA
	I _F =0mA, Vo=Vcc=18V T _A =25°C		6N139-L	-	0.1	100	
Logic low supply current	I _F =1.6mA, V _o =open (Vcc=18V)	I _{ccL}	6N138-L 6N139-L	-	0.4	1.5	mA
Logic high supply current	I _F =0mA, V _o =open ; T _A =25°C (Vcc=18V)	I _{ccH}	6N138-L 6N139-L	-	0.01	10	mA

*All Typical at $T_A = 25^\circ\text{C}$

SWITCHING SPECIFICATIONS (AC)

Parameter	Test Condition	Symbol	Device	Min	Typ	Max	Units
Propagation Delay Time to Low Output Level	$I_F=1.6\text{mA}; R_L=2.2\text{k}\Omega$	t_{PHL}	6N138-L	-	1.6	10	μs
	$I_F=0.5\text{mA}; R_L=4.7\text{k}\Omega$		6N139-L	-	5	25	
	$I_F=12\text{mA}; R_L=270\Omega$			-	0.1	1	
Propagation Delay Time to High Output Level	$I_F=1.6\text{mA}; R_L=2.2\text{k}\Omega$	t_{PLH}	6N138-L	-	10	35	μs
	$I_F=0.5\text{mA}; R_L=4.7\text{k}\Omega$		6N139-L	-	18	60	
	$I_F=12\text{mA}; R_L=270\Omega$			-	2	7	
Logic High Common Mode Transient Immunity	$I_F=0\text{mA}; V_{\text{CM}} =10\text{V}_{\text{p-p}}; R_L=2.2\text{k}\Omega$	$ CM_H $	6N138-L	1	10	-	KV/ μs
			6N139-L				KV/ μs
Logic Low Common Mode Transient Immunity	$I_F=1.6\text{mA}; V_{\text{CM}} =10\text{V}_{\text{p-p}}; R_L=2.2\text{k}\Omega$	$ CM_L $	6N138-L	1	10	-	KV/ μs
			6N139-L				KV/ μs

*All Typical at $T_A=25^\circ\text{C}$

Isolation Characteristics

Parameter	Test Condition	Symbol	Min	Typ	Max	Units
Input-Output Insulation Leakage Current	45% RH, t = 5s, V _{I-O} = 3kV DC, T _A = 25°C	I _{I-O}			1.0	μA
Withstand Insulation Test Voltage	RH ≤ 50%, t = 1min, T _A = 25°C	V _{ISO}	2500			V _{RMS}
Input-Output Resistance	V _{I-O} = 500V DC	R _{I-O}		10 ¹²		Ω

*All Typical at T_A = 25°C

Notes,

1. AC For 1 Minute, R.H. = 40 ~ 60%. Isolation voltage shall be measured using the following method.
 - (1) Short between anode and cathode on the primary side and between collector and emitter on the secondary side.
 - (2) The isolation voltage tester with zero-cross circuit shall be used.
 - (3) The waveform of applied voltage shall be a sine wave.
2. For 10 Seconds
3. Current Transfer Ratio (CTR) is defined as the ration of output collector current, I_o, to the forward LED input current, I_F, times 100%.
4. Pin 7 open.
5. Instantaneous common mode rejection voltage "output (1)" represents a common mode voltage variation that can hold the output above (1) level (V_o > 2.0V). Instantaneous common mode rejection voltage "output (0)" represents a common mode voltage variation that can hold the output above (0) level (V_o < 0.8V).
6. Device considered a two terminal device. Pins 1, 2, 3 and 4 shorted together and Pins 5, 6, 7 and 8 shorted together.

Switching Time Test Circuit

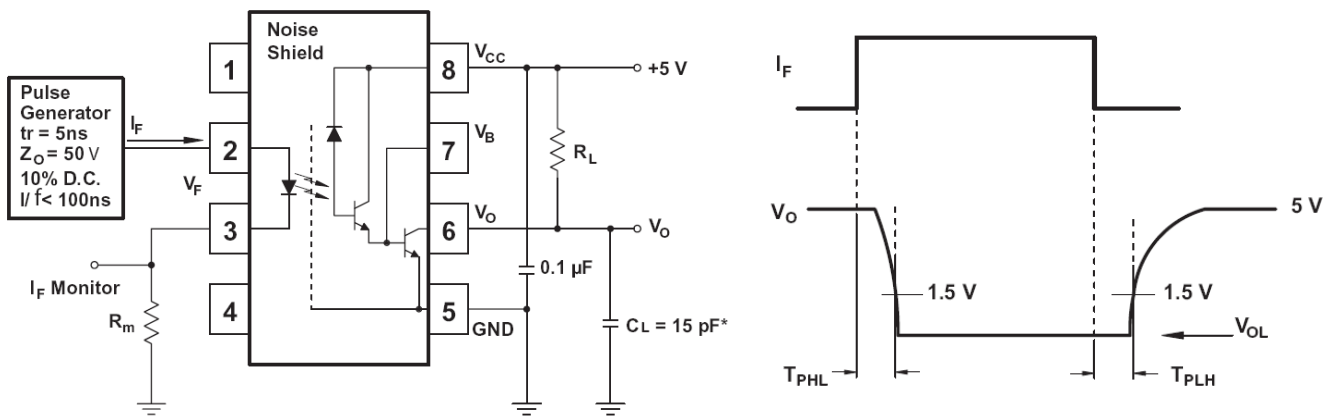


Figure 1: Single Channel Test Circuit for t_{PHL} and t_{PLH}

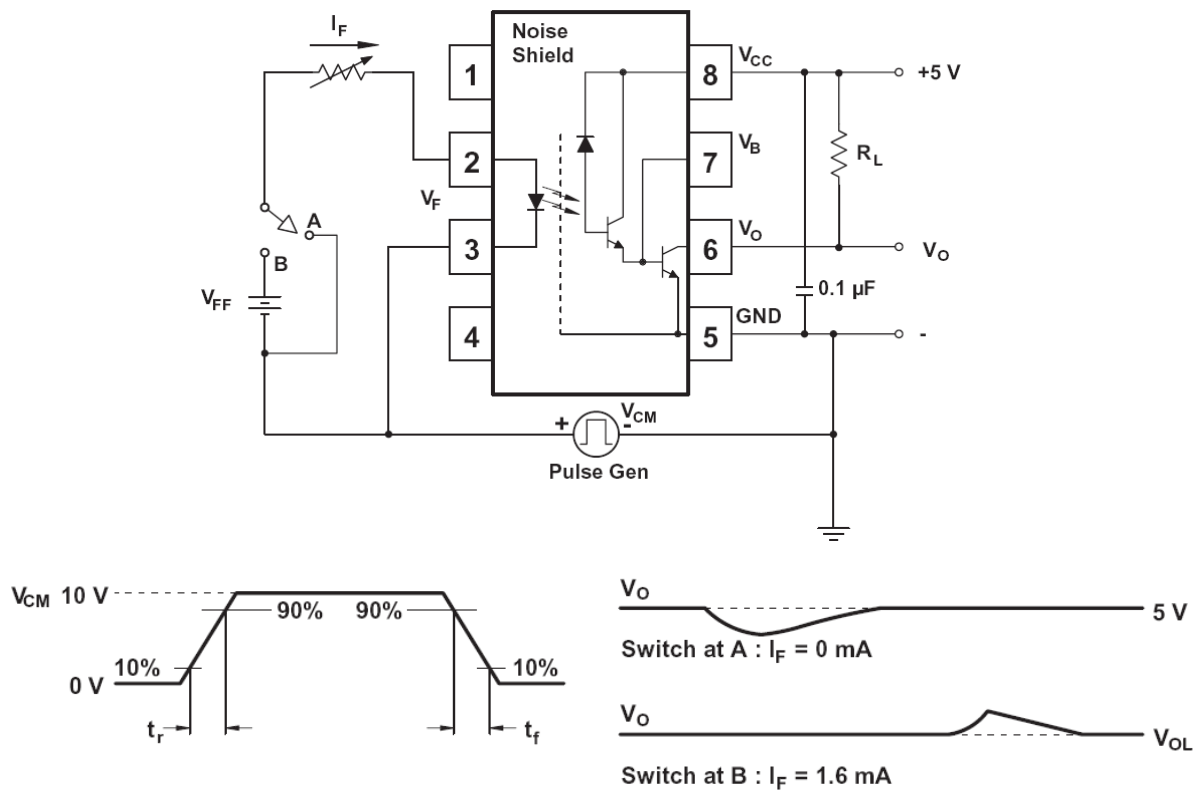


Figure 2: Single Channel Test Circuit for Common Mode Transient Immunity

LITE-ON LITE-ON TECHNOLOGY CORPORATION

Property of Lite-on Only

Characteristics Curves

Figure 3: DC transfer characteristics

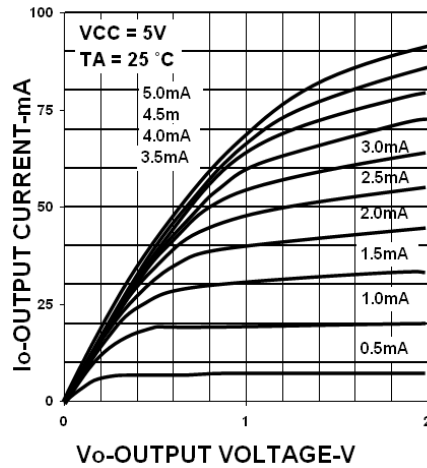


Figure 4: output current vs. input diode forward current

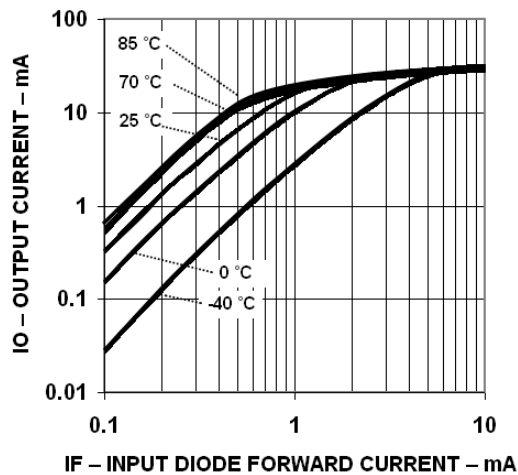


Figure 5: 6N139-L propagation delay vs. temperature

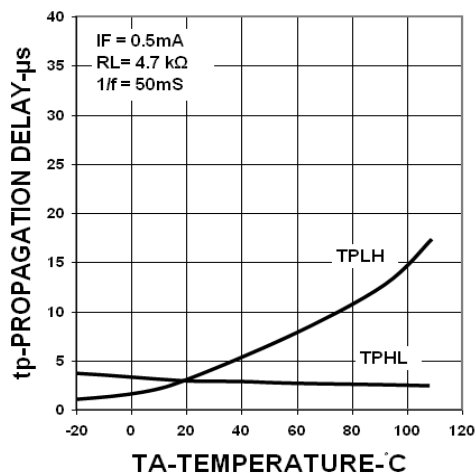


Figure 6: current transfer ratio vs. forward current

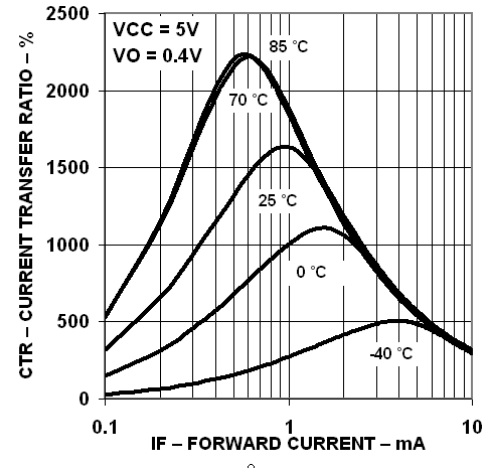


Figure 7: current transfer ratio vs. forward current

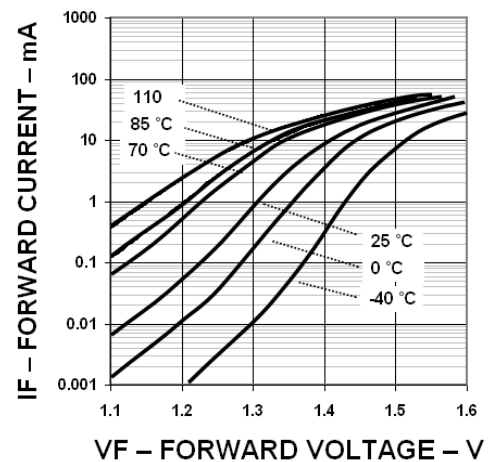
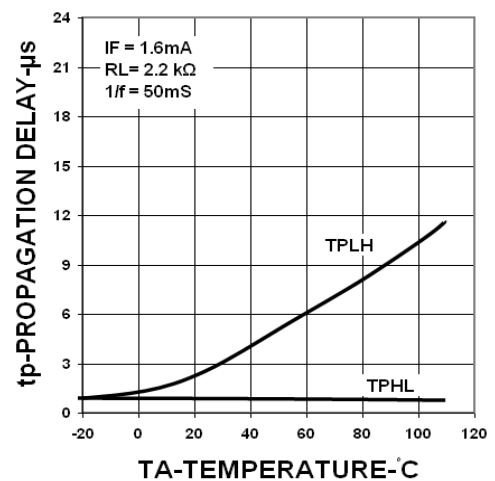


Figure 8: 6N138-L propagation delay vs.



Characteristics Curves

Figure 9: 6N139-L propagation delay vs.

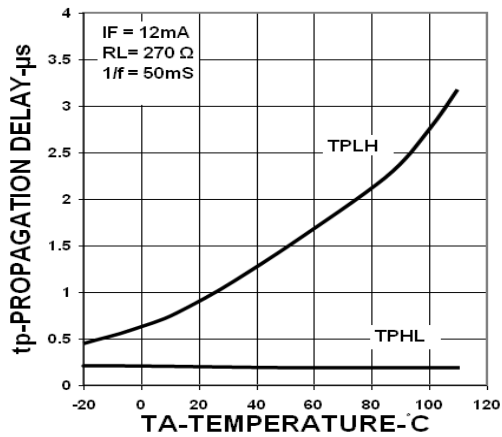


Figure 11: Forward voltage vs. temperature

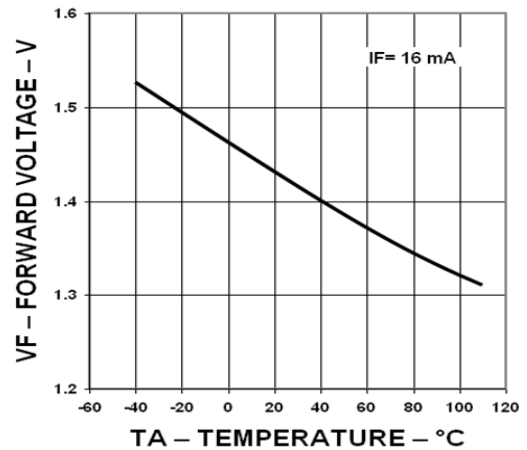


Figure 10: Nonsaturated rise and fall time vs. load resistance

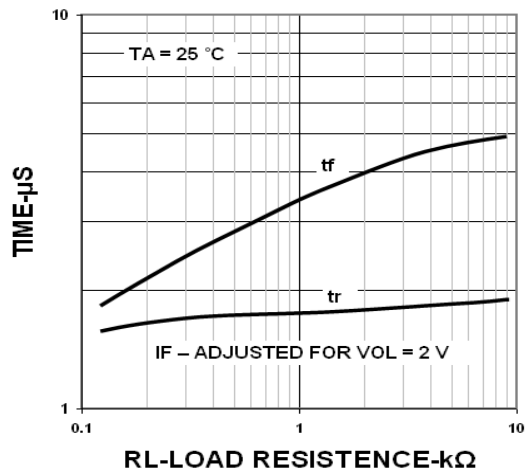
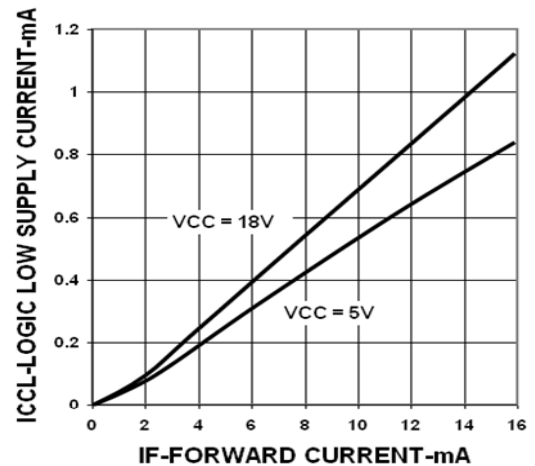


Figure 12: Logic low supply current vs. forward current



Notes:

Specifications of the products displayed herein are subject to change without notice.

The products shown in this publication are designed for the general use in electronic applications such as office automation equipment, communications devices, audio/visual equipment, electrical instrumentation and application. For equipment/devices where high reliability or safety is required, such as space applications, nuclear power control equipment, medical equipment, etc, please contact our sales representatives.